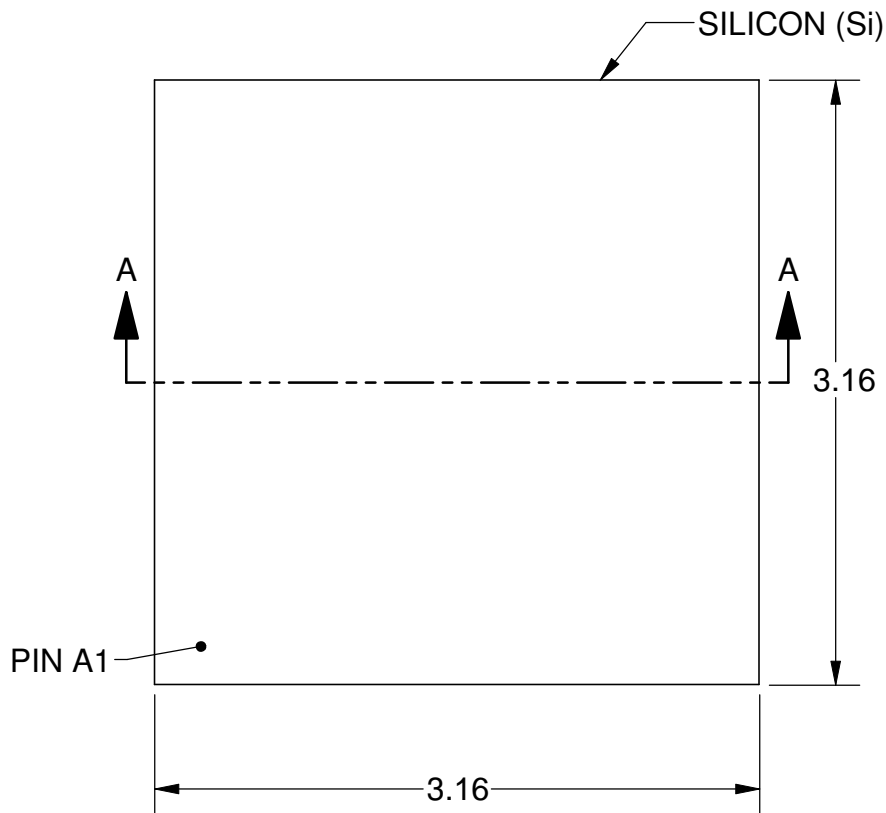
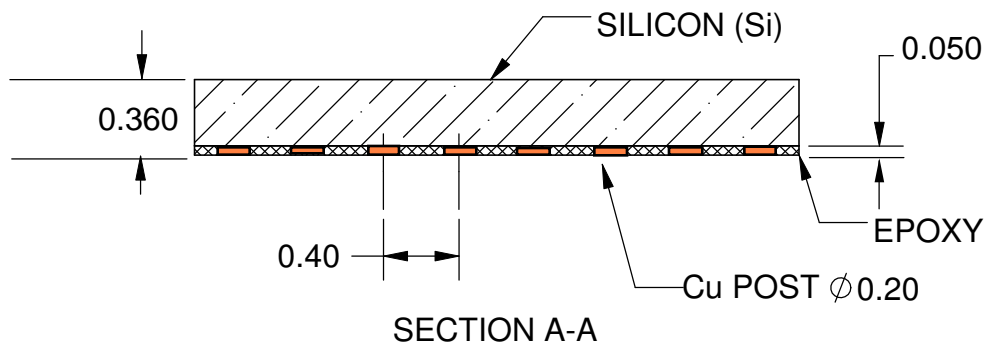
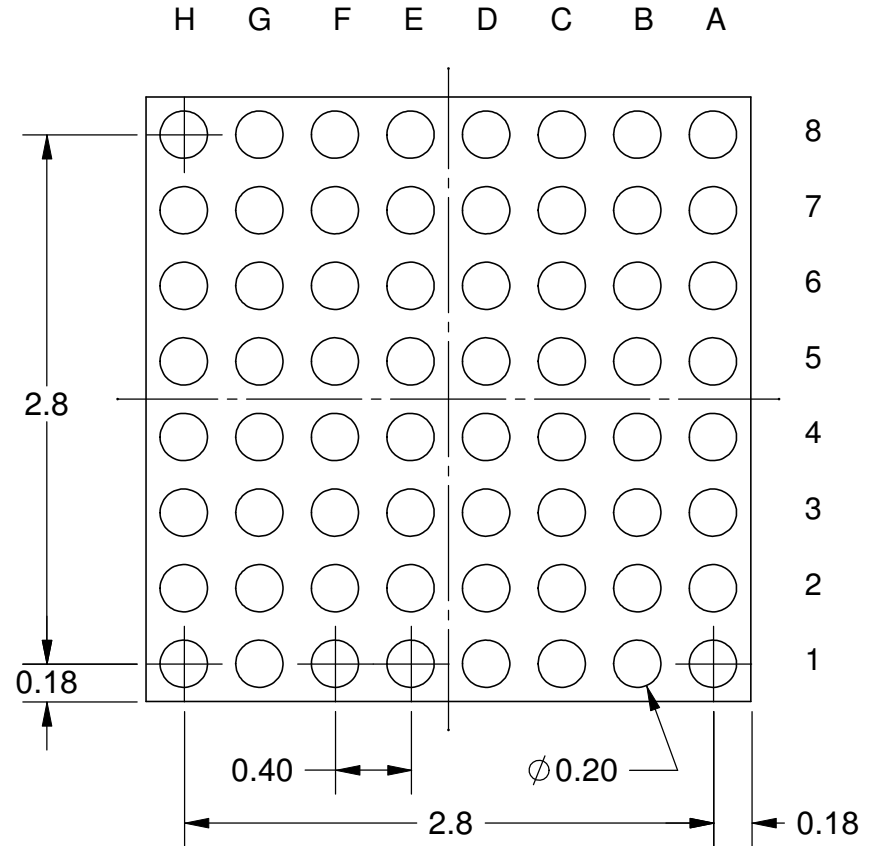


TOP VIEW


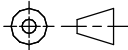


PAD VIEW



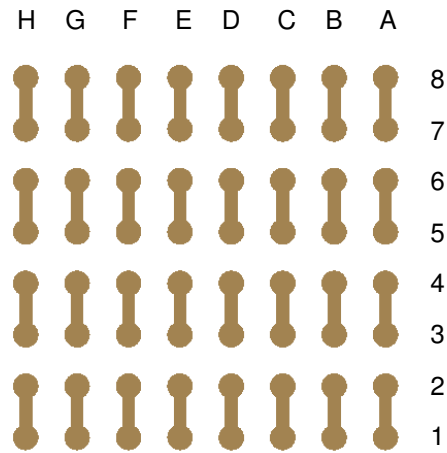
Notes: (Unless Otherwise Specified).

- 1) ALL DIMENSIONS ARE IN MM.
- 2) PAD ALLOY: Cu (50um Thick)
- 3) PAD Cu DIAMETER: 0.20mm.
- 4) DIE MATERIAL: Si (SILICON).
- 5) DAISY CHAIN PATTERN (SEE PAGE 2).

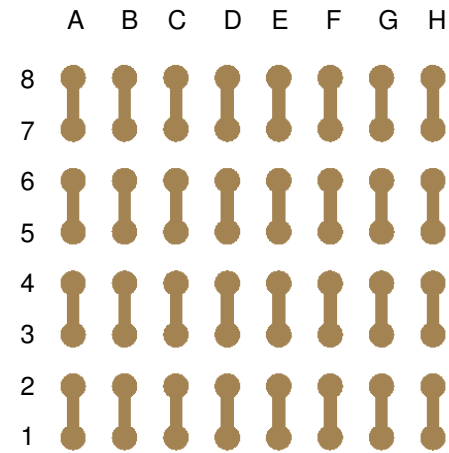
TOLERANCE UNLESS NOTED		APPROVALS		DATE		 TITLE eWLP64T.4-DC088D3 64-L P=0.4mm (TEG0408)							
X.X	+/- 0.3	DRAWN J. Hines		12/30/2010						SCALE 25:1    SIZE A    DRAWING NO. 740880    REV A			
X.XX	+/- 0.03												
X.XXX	+/- 0.003	ENG											
ANGLES +/- 0.5°		MFG											
ALL DIMENSIONS IN		THIRD ANGLE PROJECTION											
<input type="checkbox"/> INCHES <input checked="" type="checkbox"/> MILLIMETERS				QA									
		CUST											
		REVISED											
						DO NOT SCALE DRAWING		SHEET 1 OF 2					

# DAISY CHAIN PATTERN

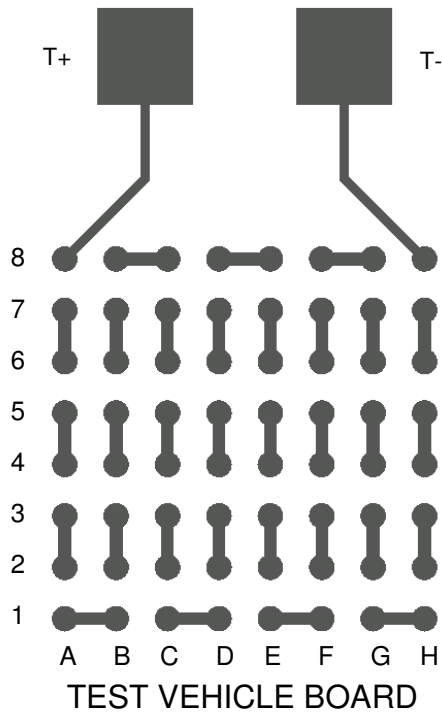
PAD VIEW



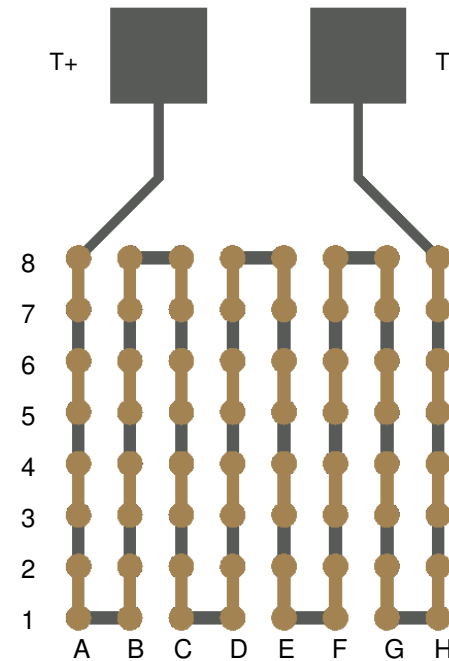
BOTTOM SIDE  
(TOP X-RAY VIEW)



TOP VIEW



AFTER MOUNTING  
TO TEST BOARD  
(TOP X-RAY VIEW)



**Notes:**

- 1) PCB BOARD DIMENSIONS ARE PRESENTED ONLY AS A GUIDELINE. DESIGNERS SHOULD USE THEIR OWN EXPERIENCE WHEN DESIGNING PCB.

<b>TopLine</b> ®			
TITLE eWLP64T.4-DC088D3 64-L P=0.4mm (TEG0408)			
SCALE 17:1	SIZE	DRAWING NO. 740880	REV A
DO NOT SCALE DRAWING		SHEET 2 OF 2	